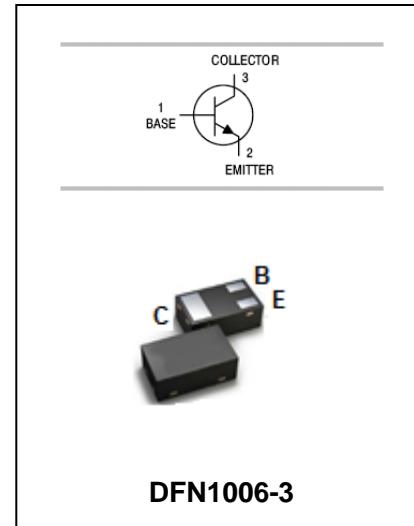




FEATURES

- Epitaxial planar die construction.
- Complementary PNP type available (MMBT3906L).
- Collector Current Capability $I_{CM} = 200\text{mA}$.
- Collector-emitter Voltage $V_{CEO}=40\text{V}$.



APPLICATIONS

- General switching and amplification

ORDERING INFORMATION

Type No.	Marking	Package Code
MMBT3904L	1AM	DFN1006-3

MAXIMUM RATING @ $T_a=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	Value	UNIT
V_{CBO}	collector-base voltage	60	V
V_{CEO}	collector-emitter voltage	40	V
V_{EBO}	emitter-base voltage	6	V
I_c	collector current (DC)	200	mA
I_{CM}	peak collector current	200	mA
I_{BM}	peak base current	100	mA
P_{tot}	total power dissipation	150	mW
T_j, T_{stg}	storage temperature	-55 to +150	°C


ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = 30$ V	-	50	nA
I_{EBO}	emitter cut-off current	$I_C = 0$; $V_{EB} = 6$ V	-	50	nA
h_{FE}	DC current gain	$V_{CE} = 1$ V; $I_C = 0.1$ mA $I_C = 1$ mA $I_C = 10$ mA $I_C = 50$ mA $I_C = 100$ mA	60 80 100 60 30	- - 300 - -	
$V_{CE(\text{sat})}$	collector-emitter saturation voltage	$I_C = 10$ mA; $I_B = 1$ mA	-	200	mV
		$I_C = 50$ mA; $I_B = 5$ mA	-	300	mV
$V_{BE(\text{sat})}$	base-emitter saturation voltage	$I_C = 10$ mA; $I_B = 1$ mA	650	850	mV
		$I_C = 50$ mA; $I_B = 5$ mA	-	950	mV
C_{obo}	Output Capacitance	$I_E = I_e = 0$; $V_{CB} = 5$ V; $f = 1$ MHz	-	4	pF
C_{ibo}	Input Capacitance	$I_C = I_c = 0$; $V_{BE} = 500$ mV; $f = 1$ MHz	-	8	pF
f_T	transition frequency	$I_C = 10$ mA; $V_{CE} = 20$ V; $f = 100$ MHz	300	-	MHz
F	noise figure	$I_C = 100$ mA; $V_{CE} = 5$ V; $R_S = 1$ kΩ; $f = 10$ Hz to 15.7 kHz	-	5	dB
Switching times (between 10% and 90% levels);					
t_d	delay time	$I_{Con} = 10$ mA; $I_{Bon} = 1$ mA; $I_{Boff} = -1$ mA	-	35	ns
t_r	rise time		-	35	ns
t_s	storage time		-	200	ns
t_f	fall time		-	50	ns

Note Pulse test: $t_p \leq 300$ ms; $d \leq 0.02$.



TYPICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified

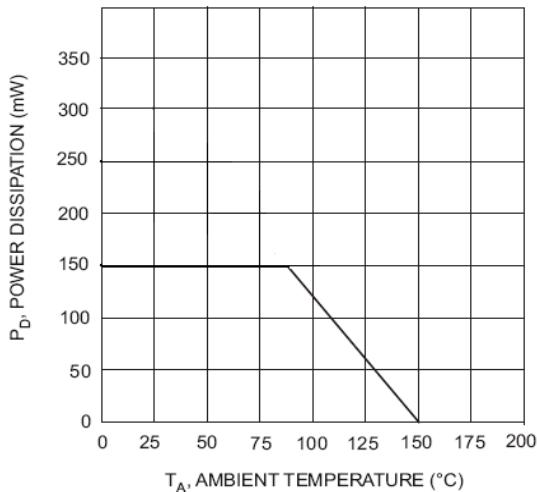


Fig. 1, Max Power Dissipation vs
Ambient Temperature

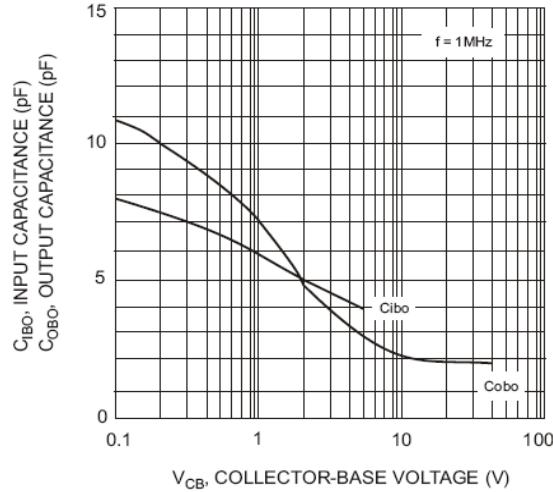


Fig. 2, Input and Output Capacitance vs.
Collector-Base Voltage

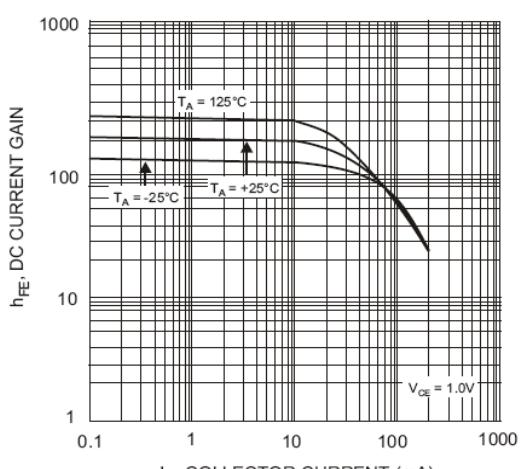


Fig. 3, Typical DC Current Gain vs
Collector Current

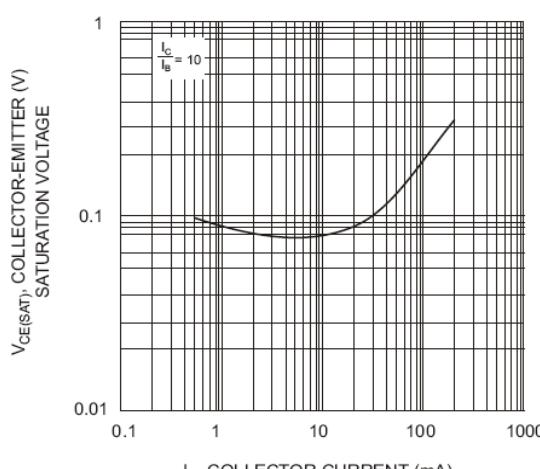


Fig. 4, Typical Collector-Emitter
Saturation Voltage vs. Collector Current

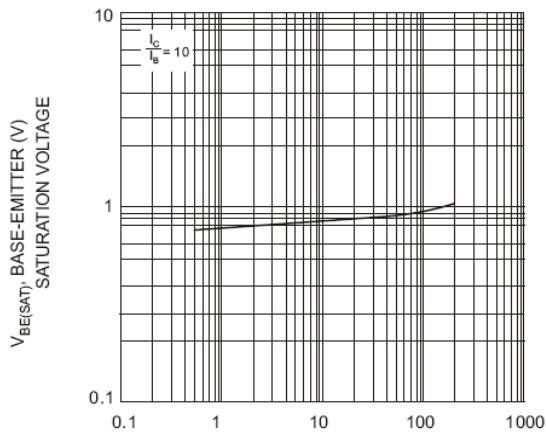


Fig. 5, Typical Base-Emitter
Saturation Voltage vs. Collector Current



PACKAGE OUTLINE

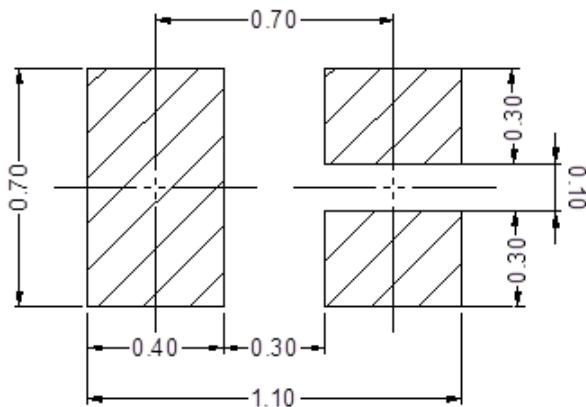
Plastic surface mounted package

DFN1006-3

DFN1006-3			
Dim	Min	Typ	Max
A	0.95	1.00	1.075
B	0.47	0.50	0.53
C	0.55	0.60	0.675
D	0.45	0.50	0.55
E/J	0.20	0.25	0.30
F	-	0.40	-
G	-	0.35	-
H	0	0.03	0.05
I	0.10	0.15	0.20

All Dimensions in mm

SOLDERING FOOTPRINT



Unit: mm

PACKAGE INFORMATION

Device	Package	Shipping
MMBT3904L	DFN1006-3	10000 pcs / Tape & Reel